



Plasmonic Circuitry

[Circuit] :

a two-way communication path between points

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The drive for optical telecommunication

Electric Datacom interconnects & RC Latency

Table 1 MOSFET and interconnect latency for 1.0-µm, 100-nm, and 35-nm-technology generations [3].

| Technology generation | $\begin{array}{l} MOSFET \ switching \ delay \\ (t_d \ = \ CV\!/\!I) \\ (\mathrm{ps}) \end{array}$ | $\begin{array}{l} RC \ response \ time \\ (L_{int} = 1 \ mm) \\ (ps) \end{array}$ | $\begin{array}{l} \textit{Time of flight} \\ (L_{int} = 1 \ mm) \\ (\text{ps}) \end{array}$ |
|-------------------------------------|--|---|---|
| 1.0 μ m (Al, SiO ₂) | ~ 20 | ~1 | ~6.6 |
| 100 nm (Cu, k = 2.0) | ~5 | ~30 | ~4.6 |
| 35 nm (Cu, $k = 2.0$) | ~2.5 | ~250 | ~4.6 |

J. D. Meindl et al. IBM J.Res. & Dev. 46, 245 (2002)

Interconnects on boards vs length



Observed distribution of electrical interconnects as a function of their lengths (average over 20 commercial microprocessors – adapted from IBM J. Res. & Dev. **46**, 245 (2002))

Anticipation of short-haul optical datacom



(by N. Savage, IEEE-Spectrum, vol. 39, Aug.2002)

Optical interconnects on boards

Advantages of optical IC at the cm length scale and around 10 GHz clock :

Attenuation:

Optical guide-wave losses < electrical lines losses. But coupling in/out losses !

Latency:

-RC effects of electrical line => longer delays than time-of-flight of signals.

- In optics : electro-optical conversion ~ time of flight of optical signal (~ 5 ps).

But, if cm-long scale, the interfacing and packaging issues are critical !

Advantages plasmon technology vs classical integrated-optics technology :

- Plasmonic device are very short and present intrinsic large bandwidth;
- Many plasmonic structures allow an efficient bending of the light wavevector.

Metal stripes surface plasmon waveguides sustain modes which are strictly confined to the width of the stripes => Advantage to avoid cross-talk.

Passive components such as surface plasmon beam splitters featuring right-angle bents have been recently demonstrated

In the case of Long-Range Surface Plasmon Polaritons (LR-SPP) modes, the typical attenuation lengths are in the mm or cm range which is compatible with the distribution of chip-to-chip interconnect lengths.

Compatibility with today silicon electronics technologies (oxide and metal deposition, lithographic processes).

Plasmonics is also compatible with current **board substrate technology**.

Plasmon propagation length



| Wavelength | Au Index | | | SPP propagation | LR-SPP propagation |
|------------|----------------|----------------|------|-----------------|--------------------|
| (nm) | | | | length (µm) | length (µm) |
| 850 | 0.196+ i 5.590 | Sapphire Index | 1,75 | 7,5 | 122 |
| | | Glass index | 1,50 | 7,6 | 220 |
| 1310 | 0.411+i 8.347 | Sapphire Index | 1,74 | 24,7 | 502 |
| | | Glass index | 1,50 | 25,1 | 902 |
| 1550 | 0.559+i 9.810 | Sapphire Index | 1,73 | 40,0 | 811 |
| | | Glass index | 1,50 | 40,6 | 1169 |

- The reference system is a 25 nm thick Au film.

- SPP data corresponds to this film deposited on sapphire or glass substrate while the upper interface is exposed to air.

- LR-SPP data are related to the same film

covered by the same material as the substrate.

Plasmonic circuitry: a recipe

Ingredients:

An excitation scheme (optical or electrical) A waveguide An active area to encode information Some routing, filtering... A detection mechanism



Waveguiding strategies

Plasmonic Crystals Kitson (Barnes' group) et al, PRL 1996; **Bozhevolnyi et al**, PRL 2001 Thin films/ TIR coupling

Metal Stripes Theory: Berini (Ottawa), PRB 2000 ; Weeber & Dereux (UB) (2001)

Thin films /TIR or end-fire coupling

Diel. WG on metal Hohenau (Krenn's group) et al, Opt. Lett. 2005

Bozhevolnyi, Zayats & Dereux groups

Thin or thick fims / coupling : TIR, end-fire

Crystalline metal nanowires Ditlbacher (Krenn's group) et al, PRL 2005

Very thin nanostructures / coupling : end-fire

Hole arrays & hole arrays components

Ebbesen's group et al (UAM,UZ, UB), APL 2003

Thick films / coupling : normal incidence

Channel SPP WG Theory: Novikov & Maradudin (Irvine), PRB 2002;

Bozhevolnyi et al (Ebbesen's group), Nature 2006

Thick films / coupling : end-fire

Stripe waveguides



Charbonneau et al. Opt. Lett. 25, 844 (2000) Lamprecht et al. Appl. Phys. Lett. 79, 51 (2001) Weeber et al. Phys. Rev. B. **68**, 115401 (2003) Zia et al. Phys. Rev. B **74**, 165415 (2006)

 ~ 1

-0.8

Atsuali posilemon

-0.2

V-groove and wedge



Novikov et al. Phys. Rev. B **66**, 035403 (2002). Pile et al. Opt. Lett. **29**, 1069 (2004) Bozhevolnyi et al. Phys. Rev. Lett. **95**, 046802 (2005) Bozhevolnyi et al. Nature, **440** 508 (2006)



Moreno et al. Phys. Rev. Lett. **100**, 023901 (2005) Boltasseva et al. Opt. Exp., **15** 5252 (2006)

Plasmonic crystal waveguides





Bozhevolnyi et al. Opt. Lett, **36** 734 (2001) Weeber et al. Appl. Phys. Lett **89**, 211109 (2006)

Slot waveguides





Tanaka et al. Appl. Phys. Lett. **82**, 1158 (2003) Wang et al. Opt. Lett. **29** 1992 (2004) Tanaka et al. Opt. Exp **13**, 256 (2005) Dionne et al. Nano. Lett. **6**, 1928 (2006)

Nanowires





Weeber et al. Phys. Rev. B **60**, 9061 (2000) Dickson et al. J. Phys. Chem. B **104**, 6095 (2000) Ditlbacher et al. Phys. Rev. Lett. **95**, 257403 (2005) Gunn et al. Nano. Lett, **6**, 2804 (2006)

Waveguiding in metal stripes



Plasmon is confined and propagates, but the mode has a cut-off width:



Confinement



Stripe SP mode spreading



Strong field confinement => large spreading

Alternative technology: DLSPPW

DLSPPW: dielectric-loaded surface plasmon waveguide

- High-density photonic circuitry
 Perspective for reduced losses
- Can be doped!
 - Electro-optical
 - Photo-switchable
 - Non-linear





Propagation

Surface plasmon decay length





Plasmonic circuitry





Routing with metal stripes

• Routing by bends













Integrated surface plasmon Bragg mirrors



SP Goos-Hänschen effect



Integrated SP splitters

Bragg splitters (reflectivity depends of the number of Bragg lines)









Integrated SP multiplexers



A. Drezet et al., Nano Lett., <u>7</u>, 1697(2007)

Routing with DLSPPW: couplers

PHYSICAL REVIEW B 78, 045425 (2008)

Three-dimensional numerical modeling of photonic integration with dielectric-loaded SPP waveguides

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Routing with DLSPPW: filters, couplers





Routing with V-grooves





V. Volkov et al., Nano Lett, asap (2009)

Surface plasmon cavity

Ζ

Locally enhancing plasmon interactions





Resonant conditionsField enhancementQuality factor

Resonance condition



Field enhancement and quality factor

Predictions

$$\eta = \frac{\int_{\Omega} E_{\text{cavity}}^2(x) \, dx}{\int_{\Omega} E_{\text{mirror}}^2(x) \, dx}$$



Experiments



Phys. Rev. B 76, 113405 (2007)

Plasmonic circuitry



Surface plasmon launchers: hole arrays



Fig. 4. (Color online) (a) SEM image $(52^{\circ} \text{ tilt})$ of a convex shaped source array with the corresponding NFO image (b) and simulations taking into account the finite size of the illumination spot (c) versus uniform illumination (d). (e) SEM image $(52^{\circ} \text{ tilt})$ of a concave shaped source array with the corresponding NFO image (f) and simulation (g). Simulations have the same scale as NFO images.

Surface plasmon launchers: slits/grooves

Nature Physics (2007)



Left column: isolated slit.

Right column: slit+grating.

PSTM images recorded at lambda=800 nm for two different slit-grating distances. Slit and groove widths a=160 nm groove depth w=100 nm array period P=390 nm

Electrical injection of SPP

Organic plasmon-emitting diode

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Plasmonic circuitry



Thermo-optical modulation



All-optical modulation



Field-effect modulation



A. Dionne et al., *Nano Lett*. asap (2009)



| λ=1.55µm | E mode profile | Mode Index | Loss (dB/µm) |
|--------------------------|----------------------|---------------|-----------------|
| Off state | Ag /SiO ₂ | 3.641 | 0.207 |
| depletion | Ag | 0.375 | 2.37 |
| On state | Ag /SiO2 | 3.649 | 0.228 |
| (v>0.7V) accumulation | Ag | 0.033 | 28.14 |

5 µm

Liquid crystal modulation

Liquid crystal = Mesophase (intermediary between liquid and crystalline states)

Present orientational or / and positional order



Anisotropic behaviour



Modification of their optical properties with the application of an electric field

• Nematic LC ~ Uniaxial medium

$$\implies \Delta n = |n_e - n_o| > 0.1$$
(0.2 for E7)



Propagation distance

• Possible interactions between a plasmon and a birefringent medium:



- Modification of the SPP propagation constant (real and imaginary parts) when an electric field is applied on the LC.
- Relative variations for n_{eff} and L_{sp} for In plane and Out of plane configurations:



In-plane switching: proof-of-principle



Possible device based on LR-SPP

• Long-range surface plasmon polariton propagation:



- Thin metal film (~15 nm)
- Symmetric configuration
- Propagation length expected : ~ cm

• Principle of the device:



Insertion of a trench filled with LC in order to:

- break the index matching between the two layers surrounding the metal film
- bring a polarization rotation of the signal

Device fabrication



In-out coupling

LRSPP excitation by butt-coupling technique: ullet



LR-SPP modulation

• « Slow » modulation frequency:





Between crossed polarizers



• Response with different modulation frequencies:







Plasmonic circuitry



Gain medium: polymer-doped with QDs



J. Grandidier et al., Nano Lett. 9, 2935 (2009)

Stimulated emission of SPP



Optical gain



Plasmonic circuitry



Plasmon diode



Fig.2 (a) Experimental setup, (b) optical reflection microscopy image, (c) corresponding induced current map. For details see text and supplementary file.

Plasmon power monitor



Fig. 2. Optical microscopy images with low (left) and high (right) magnifications of the fabricated WRR structures having rings with separate electrical access for the purposes of (thermo-optic) control of the WRR operation or to monitor the transmitted power via measuring the signal electrode resistance (whose change is determined by the absorbed power).

Bozhevolnyi (SDU)

Plasmon power monitor



Electrical detection





A. Falk. et al. Nat. Phot. DOI 10.1038 (2009).

Figure 1 | **Electrical plasmon detection. a**, Schematic diagram of electrical plasmon detector operation. Inset: Electron-hole pair generation and separation in the Ge nanowire detector. **b**, Scanning electron micrograph of device 1, overlaid with the current through the Ge nanowire as a function of excitation laser position. Excitation laser power $P = 2.0 \,\mu$ W, wavelength $\lambda_{ex} = 532 \,\text{nm}, V_b = 0, V_{gate} = 0.$

Plasmonic circuitry



So, where are we?

SPP interconnect demonstrator

VCSEL coupling test using self supported LR-SPP waveguide

2.5 Gbps/channel; 6dB/cm propag. Loss



Fig. 1. Architectural view of on-board chip-to-chip optical interconnect using polymer-based Au long-range surface plasmon polariton (LR-SPP) waveguide.

Optics Express, 16 13133 (2008)

Interconnects for Tb control boards



Disclaimer: I fully agree with Kobus' remark

Interconnects for Tb control boards



Interconnects for Tb control boards



Hybrid technology: Silicon (SOI)+DLSPPW



(b)





Surface plasmon-based circuitry is becoming a technological reality! The toolkit is practically complete (inc. SP Lasers)





Bio-plasmonics, integrated plasmonics & molecular plasmonics

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Microwave attenuation



• Further reduction in attenuation is expected as fabrication processes are optimised.

Board technology with Au is Si-compatible



Example of currently available Microwave Au circuit printed on Sapphire.

Both the substrate and the metal stripes are potentially suitable for plasmon propagation if downsizing to micrometre widths and to millimetres lengths is mastered.